Preferred Device

Darlington Complementary Silicon Power Transistors

These devices are designed for general-purpose amplifier and low-speed switching motor control applications.

Features

- Similar to the Popular NPN 2N6284 and the PNP 2N6287
- Rugged RBSOA Characteristics
- Monolithic Construction with Built-in Collector-Emitter Diode
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector–Emitter Voltage	V_{CEO}	100	Vdc
Collector-Base Voltage	V _{CB}	100	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current – Continuous – Peak	I _C	20 40	Adc
Base Current	Ι _Β	0.5	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	160 1.28	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.78	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

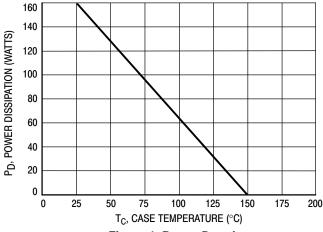


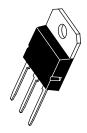
Figure 1. Power Derating



ON Semiconductor®

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DARLINGTON 20 AMPERE COMPLEMENTARY SILICON POWER TRANSISTORS 100 VOLTS, 160 WATTS



SOT-93 (TO-218) CASE 340D



MARKING DIAGRAM

A = Assembly Location

Y = Year

WW = Work Week

G = Pb-Free Package

MJH628x = Device Code

x = 4 or 7

ORDERING INFORMATION

Device	Package	Shipping
MJH6284	SOT-93	30 Units / Rail
MJH6284G	SOT-93 (Pb-Free)	30 Units / Rail
MJH6287	SOT-93	30 Units / Rail
MJH6287G	SOT-93 (Pb-Free)	30 Units / Rail

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

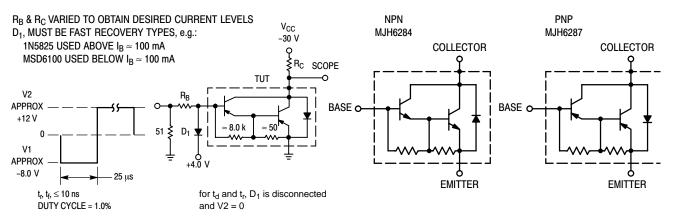
ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (I _C = 0.1 Adc, I _B = 0)	V _{CEO(sus)}	100	_	Vdc	
Collector Cutoff Current (V _{CE} = 50 Vdc, I _B = 0)	I _{CEO}	-	1.0	mAdc	
Collector Cutoff Current $(V_{CE} = Rated \ V_{CB}, \ V_{BE(off)} = 1.5 \ Vdc)$ $(V_{CE} = Rated \ V_{CB}, \ V_{BE(off)} = 1.5 \ Vdc, \ T_{C} = 150 ^{\circ}C)$	I _{CEX}	- -	0.5 5.0	mAdc	
Emitter Cutoff Current (V _{BE} = 5.0 Vdc, I _C = 0)	I _{EBO}	-	2.0	mAdc	
ON CHARACTERISTICS (Note 1)					
DC Current Gain ($I_C = 10$ Adc, $V_{CE} = 3.0$ Vdc) ($I_C = 20$ Adc, $V_{CE} = 3.0$ Vdc)	h _{FE}	750 100	18,000	-	
Collector–Emitter Saturation Voltage ($I_C = 10 \text{ Adc}, I_B = 40 \text{ mAdc}$) ($I_C = 20 \text{ Adc}, I_B = 200 \text{ mAdc}$)	V _{CE(sat)}	- -	2.0 3.0	Vdc	
Base–Emitter On Voltage (I _C = 10 Adc, V _{CE} = 3.0 Vdc)	V _{BE(on)}	-	2.8	Vdc	
Base-Emitter Saturation Voltage (I _C = 20 Adc, I _B = 200 mAdc)	V _{BE(sat)}	-	4.0	Vdc	
DYNAMIC CHARACTERISTICS					
Current–Gain Bandwidth Product (I _C = 10 Adc, V _{CE} = 3.0 Vdc, f = 1.0 MHz)	f _T	4.0	_	MHz	
\ CD	C _{ob} 16284 16287	- -	400 600	pF	
Small-Signal Current Gain (I _C = 10 Adc, V _{CE} = 3.0 Vdc, f = 1.0 kHz)	h _{fe}	300	-	_	

SWITCHING CHARACTERISTICS

			Typical		
	Resistive Load	Symbol	NPN	PNP	Unit
Delay Time		t _d	0.1	0.1	μs
Rise Time	$V_{CC} = 30 \text{ Vdc}, I_{C} = 10 \text{ Adc}$	t _r	0.3	0.3	
Storage Time	- I _{B1} = I _{B2} = 100 mA Duty Cycle = 1.0%	t _s	1.0	1.0	
Fall Time		t _f	3.5	2.0	

^{1.} Pulse test: Pulse Width = 300 μ s, Duty Cycle = 2.0%.



For NPN test circuit reverse diode and voltage polarities.

Figure 2. Switching Times Test Circuit

Figure 3. Darlington Schematic

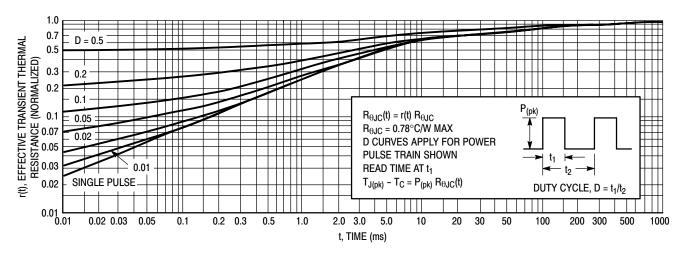


Figure 4. Thermal Response

FBSOA, FORWARD BIAS SAFE OPERATING AREA

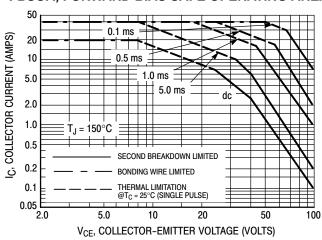


Figure 5. MJH6284, MJH6287

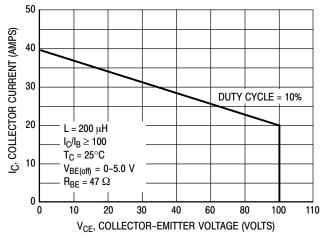


Figure 6. Maximum RBSOA, Reverse Bias Safe Operating Area

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

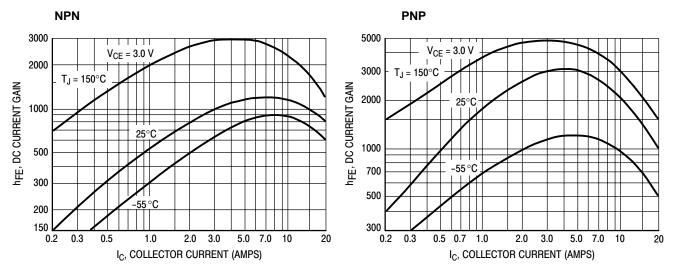


Figure 7. DC Current Gain

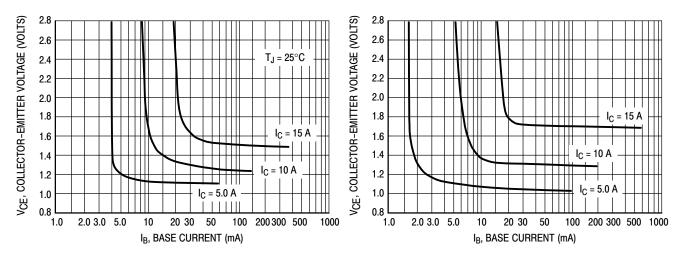


Figure 8. Collector Saturation Region

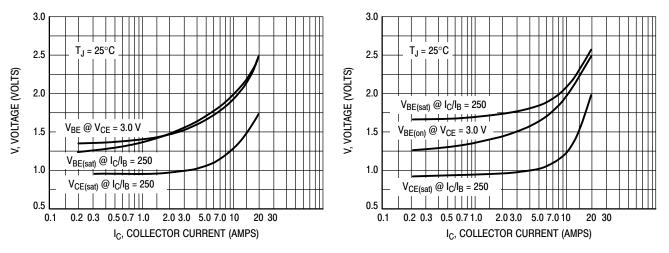
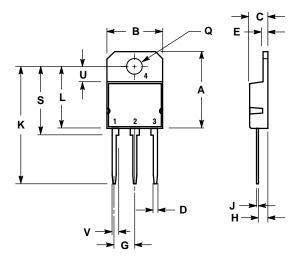


Figure 9. "On" Voltages

PACKAGE DIMENSIONS

SOT-93 (TO-218) CASE 340D-02 ISSUE E



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α		20.35		0.801	
В	14.70	15.20	0.579	0.598	
С	4.70	4.90	0.185	0.193	
D	1.10	1.30	0.043	0.051	
E	1.17	1.37	0.046	0.054	
G	5.40	5.55	0.213	0.219	
Н	2.00	3.00	0.079	0.118	
J	0.50	0.78	0.020	0.031	
K	31.00 REF		1.220	1.220 REF	
L		16.20		0.638	
Q	4.00	4.10	0.158	0.161	
S	17.80	18.20	0.701	0.717	
U	4.00	.00 REF 0.157 REI		REF	
٧	1.75 REF		0.0)69	

STYLE 1:

1. BASE

COLLECTOR

. EMITTER

4 COLLECTOR

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